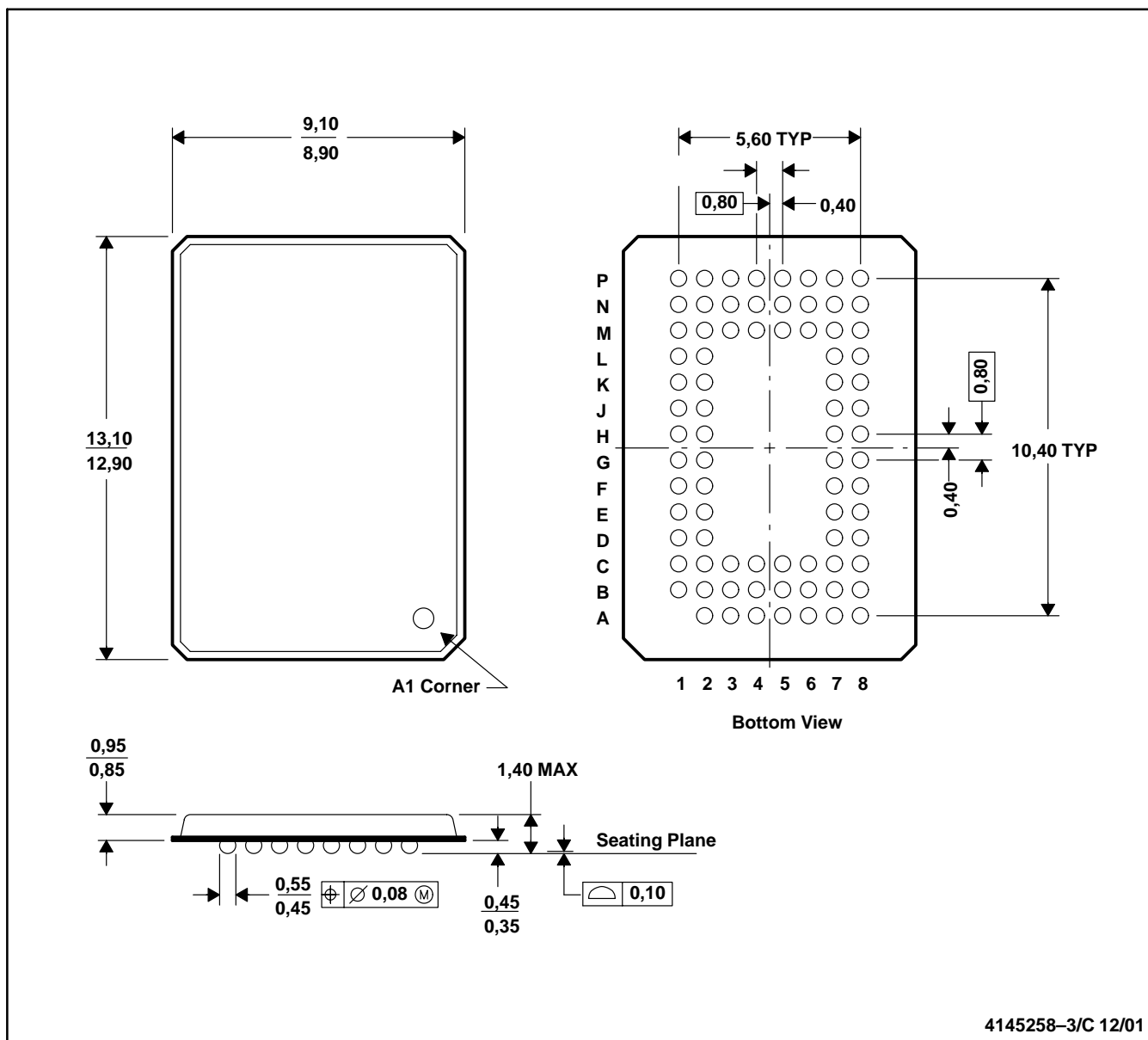


GHB (R-PBGA-N79)

PLASTIC BALL GRID ARRAY



4145258-3/C 12/01

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. MicroStar BGA configuration.

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